	毅耀實業股份有限公司 Young Yak Enterprise Co., Ltd	PRODUCT SPECIFICA	ΓΙΟΝ	Part Numl	ber: YY-2900
Title:	le: 5.08mm(.200") Pitch Wire to board Connector		Page	REV:	Document NO
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Product name & Part number

Product name	Part number
Housing	YY-2900-H-GT
Wafer	YY-2900-WR&WS
Terminal	YY-2500-T

Product Specifications

Iten	Standartd
Rated Voltage	250V AC,DC
Rated Current	7A
Withstanding Resistan	1500V AC/minute
Insulation Resistance	1000M Ohms/Min
Temperatur Range	-25°C ~+85°C

Material

Product name		Material		
Housing		Nylon 66 UL 94V-2		
Wafer	Body	Nylon 66 UL 94V-2		
	Pin	Brass/Tin-plated		
Terminal		Brass/Tin/Gold-plated		
		Phosphor Bronze/Tin-plate		

Mechanical Performance

Item	Test Condition	Requirement	
Insertion and Withdrawal Force	Insert and Withdraw connectors at the speed rate of 25±3mm/minute	1.0Kgf(MAX Insertion force) 0.15Kgf(MIN Withdrawal force)	
Terminal/ Housing Retention Force	Apply axial pull out force at the speed rate of on the terminal assembled in the housing	3.0Kgf MIN	
Contact retention force	Axial pullout force on the terminal in the housing at a rate of 25±3mm per minute	7 5K at(Min retention tarce)	
	Apply an axial pullout force on the wire at a rate of 25±3mm	AWG #16 13.7Kgf (MIN)	
Crimping Pull Out		AWG #18 9.1Kgf (MIN)	
Force		AWG #20 8.2Kgf (MIN)	
1 OICC		AWG #22 4.6Kgf (MIN)	
		AWG #24 3.0Kgf (MIN)	

Environmental Performance

Item	Test Condition	Requirement	
Solderability	Soldering Time:3±0.5sec Solder Temperature:235±5°C	Minimum:95% of immersed area	
Resistance to soldering heat	Dip connector terminal tails in solder Soldering Time:5±0.5sec Solder Temperature: 235±5°C	NO Damage	

CREATED	CHECKED	APPROVED	DATE
Louis	Louis	Jinsong.T	2006/8/30
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